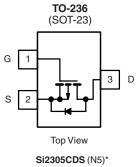


**Vishay Siliconix** 

## P-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
	0.035 at V <sub>GS</sub> = - 4.5 V	- 5.8				
- 8	0.048 at V <sub>GS</sub> = - 2.5 V	- 5.0	12 nC			
	0.065 at V <sub>GS</sub> = - 1.8 V	- 4.3				



\* Marking Code

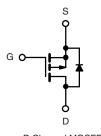
Ordering Information: Si2305CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Load Switch for Portable Devices
- DC/DC Converter



P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> T <sub>A</sub> = 25 °C, unles	ss otherwise no	ted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 8	v		
Gate-Source Voltage		V <sub>GS</sub>	± 8	v	
	T <sub>C</sub> = 25 °C		- 5.8		
	T <sub>C</sub> = 70 °C		- 4.7		
Continuous Drain Current ( $T_J = 150 \ ^\circ C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.4 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 3.5 <sup>a, b</sup>	А	
Pulsed Drain Current (10 µs Pulse Width)		I <sub>DM</sub>	- 20		
	T <sub>C</sub> = 25 °C		- 1.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 0.8 <sup>a, b</sup>		
	T <sub>C</sub> = 25 °C		1.7		
	T <sub>C</sub> = 70 °C		1.1	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.96 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C		0.62 <sup>a, b</sup>	1	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 5 s	R <sub>thJA</sub>	100	130	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	60	75	0/10	
Notes:			•			

a. Surface mounted on 1" x 1" FR4 board.



COMPLIANT HALOGEN

FREE

b. t = 5 s.

c. Maximum under steady state conditions is 175 °C/W.

d. T<sub>C</sub> = 25 °C.

## Si2305CDS

## Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	- 8			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J		- 9		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.5		- mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.4		- 1	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA
		$V_{DS} = -8 V, V_{GS} = 0 V$			- 1	μΑ
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -8 V, V_{GS} = 0 V, T_{J} = 55 °C$			- 10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS}$ = - 4.5 V	- 10			A
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.4 A		0.028	0.035	Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 3.8 A		0.039	0.048	
	()	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 2 A		0.053	0.065	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = - 4 V, I <sub>D</sub> = - 4.4 A		17		S
Dynamic <sup>b</sup>	010					
Input Capacitance	C <sub>iss</sub>			960		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 4 V, V <sub>GS</sub> = 0 V, f = 1 MHz		330		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			300		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = - 4 V, V <sub>GS</sub> = - 8 V, I <sub>D</sub> = - 4.4 A		20	30	
Total Gate Charge	Q <sub>g</sub>			12	18	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 4 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.4 A		1.5	10	
Gate-Drain Charge	Q <sub>gd</sub>			3.1		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1	5.1	10.2	Ω
Turn-On Delay Time	, , , , , , , , , , , , , , , , , , ,	1 - 1 10112	I	20	30	52
Rise Time	t <sub>d(on)</sub> t <sub>r</sub>	V <sub>DD</sub> = - 4 V, R <sub>I</sub> = 1.1 Ω		20	30	
Turn-Off Delay Time		$V_{DD} = -4 V, \ \Pi_{L} = 1.1 \Omega^{2}$ $I_{D} \cong -3.5 \text{ A}, \ V_{GEN} = -4.5 \text{ V}, \ \Pi_{a} = 1 \Omega$		40	60	-
Fall Time	t <sub>d(off)</sub> t <sub>f</sub>			40 10	15	
				10	15	ns
Turn-On Delay Time Rise Time	t <sub>d(on)</sub> t <sub>r</sub>			-	15	-
		$V_{DD} = -4 \text{ V},  \text{R}_{\text{L}} = 1.1 \Omega$ $\text{I}_{\text{D}} \cong -3.5  \text{A},  \text{V}_{\text{GEN}} = -8  \text{V},  \text{R}_{\text{q}} = 1 \Omega$		10		-
Turn-Off Delay Time	t <sub>d(off)</sub>	1D = 0.073, VGEN = 0.07, Hg = 1.22		35	55	-
Fall Time	t <sub>f</sub>			10	15	
Drain-Source Body Diode Characterist Continuous Source-Drain Diode Current	1	T <sub>C</sub> = 25 °C			14	
Pulse Diode Forward Current	l <sub>S</sub>	10-20 0			- 1.4 - 20	A
Body Diode Voltage	I <sub>SM</sub>	I <sub>S</sub> = - 3.5 A, V <sub>GS</sub> = 0 V		0.0		v
, ,	V <sub>SD</sub>	$i_{\rm S} = -0.5$ Å, $v_{\rm GS} = 0$ v		- 0.8	- 1.2	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			35	55	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 3.5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		14	25	nC
Reverse Recovery Fall Time	t <sub>a</sub>			16		ns

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

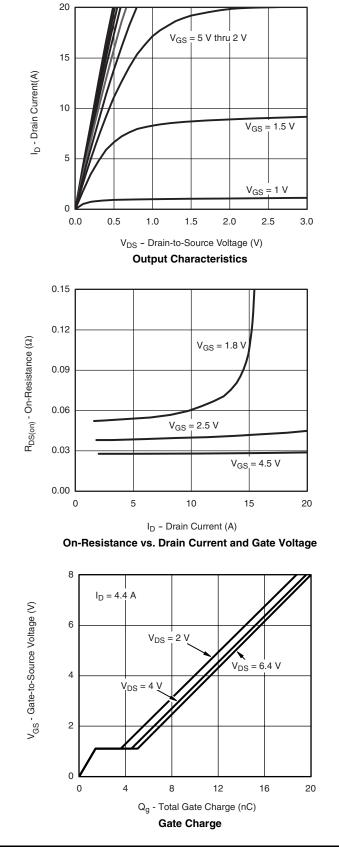
b. Guaranteed by design, not subject to production testing.

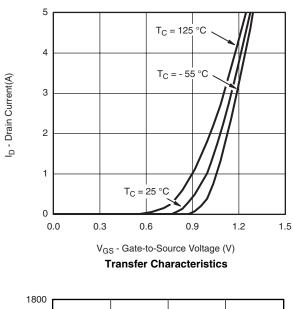
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

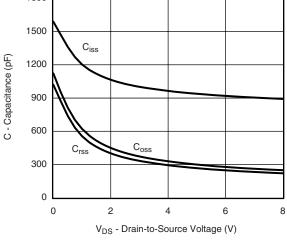


### Si2305CDS Vishay Siliconix

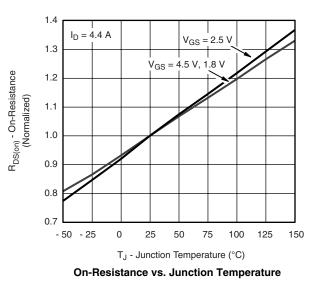
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Capacitance



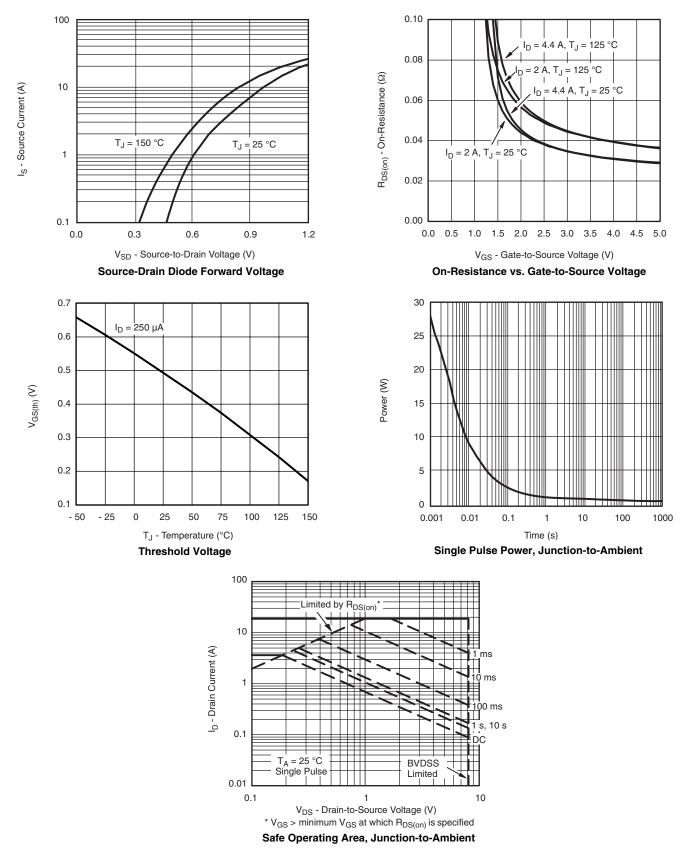
Document Number: 64847 S10-0720-Rev. C, 29-Mar-10

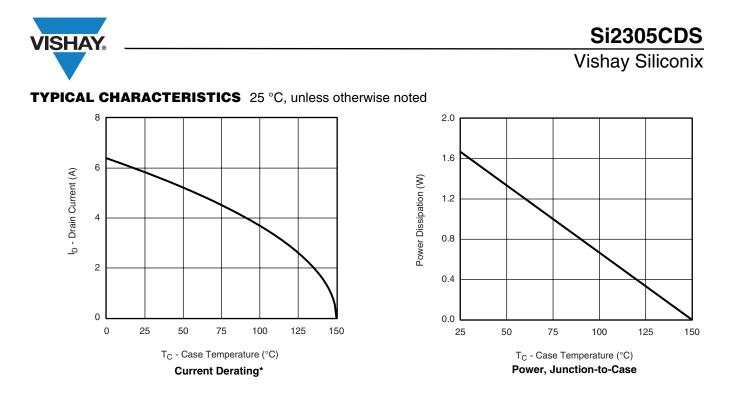
## Si2305CDS

#### Vishay Siliconix



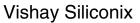
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





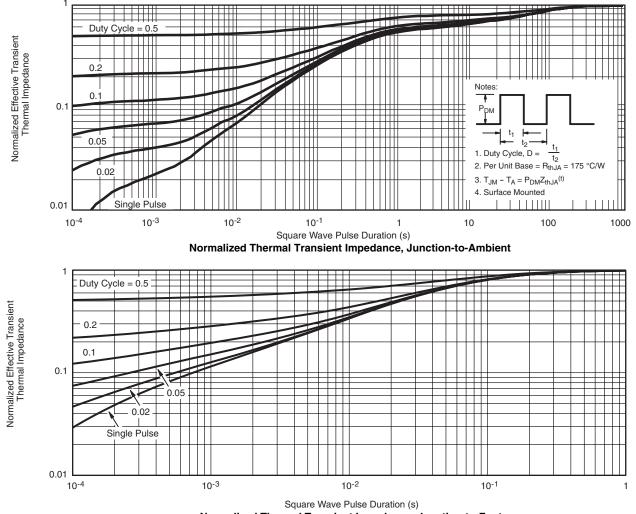
\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## Si2305CDS





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?64847">www.vishay.com/ppg?64847</a>.



## Package Information

Vishay Siliconix

#### SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



# Application Note 826

Vishay Siliconix

#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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